505564139 07/10/2019

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5610936

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
FENG ZHOU	02/22/2018
ERCAN MEHMET DEDE	02/22/2018

RECEIVING PARTY DATA

Name:	TOYOTA MOTOR ENGINEERING & MANUFACTURING NORTH AMERICA, INC.			
Street Address:	6565 HEADQUARTERS DRIVE W1-3C			
City:	PLANO			
State/Country:	TEXAS			
Postal Code:	75024			

PROPERTY NUMBERS Total: 1

Property Type	Number			
Application Number:	16507272			

CORRESPONDENCE DATA

Fax Number: (513)977-8141

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 513-977-8200

Email: ashlee.emig@dinsmore.com, Patents@Dinsmore.com

Correspondent Name: DINSMORE & SHOHL LLP

Address Line 1: 255 EAST FIFTH STREET, SUITE 1900

Address Line 4: CINCINNATI, OHIO 45202

ATTORNEY DOCKET NUMBER:	TOY2017-580NA/22562-5720
NAME OF SUBMITTER:	ANTHONY L. PISANO
SIGNATURE:	/Anthony L. Pisano/
DATE SIGNED:	07/10/2019

Total Attachments: 2

source=22562-5270 Assignment (TEMA)#page1.tif source=22562-5270 Assignment (TEMA)#page2.tif

PATENT 505564139 REEL: 049710 FRAME: 0906

ASSIGNMENT

WHEREAS, we, Feng Zhou, of 58575 Winnowing Cir S, South Lyon, MI 48178 and Ercan Mehmet Dede of 2227 Placid Way, Ann Arbor, MI 48105, hereinafter the ASSIGNORS, invented certain new and useful METHOD OF ETCHING MICROELECTRONIC MECHANICAL SYSTEM FEATURES IN A SILICON WAFER for which we executed an application for a United States Patent and for which said application for United States Patent was filed on March 13, 2018 , under

	Patent Appl	ication Sen	ial No. 1	5/919,	889		
X	Attorney D	ocket No	22562-2	2517/	<u> 2017-5</u>	80	

WHEREAS, the ASSIGNORS hereby authorize and request the attorney(s) and/or agent(s) empowered to act on Toyota Motor Engineering & Manufacturing North America, Inc.'s behalf in the aforementioned application, to insert above the filing date and application number of said application, when known;

WHEREAS, Toyota Motor Engineering & Manufacturing North America, Inc., a corporation of the State of Kentucky, with a place of business at 6565 Headquarters Drive W1-3C, Plano, Texas 75024, hereinafter called the ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to said application and the inventions therein disclosed and any Letters Patent that may issue thereon;

AND, WHEREAS, it is the intent of the ASSIGNORS to assign all rights to the above-referenced application to the ASSIGNEE, including, but not limited to, all substantive rights in the above-referenced application as well as the right to claim priority, the right to be granted a patent in any and all countries and Regional Patent Offices, including, without limitation, the PCT Contracting States;

NOW, THEREFORE, for good and valuable consideration, receipt whereof is hereby acknowledged, ASSIGNORS hereby sell, assign and transfer unto said ASSIGNEE, its successors and assigns, the entire right, title and interest, including the right to claim priority in and to said application, the inventions therein disclosed, and any improvements thereon, and in any and all Letters Patent that may be granted therefor in the United States and its territorial possessions and in any and all countries and Regional Patent Offices, including, without limitation, the PCT Contracting States, and in and to any and all divisions, continuations, substitutions, renewals, re-examinations, extensions and reissues thereof;

ASSIGNORS hereby authorize and request the Patent Office Officials in the United States and its territorial possessions, and in any and all countries and Regional Patent Offices, including, without limitation, the PCT Contracting States, to issue, when granted, any Letters Patent thereon, and any and all divisions, continuations, substitutions, renewals, re-examinations, extensions and reissues thereof, to said ASSIGNEE, its successors and assigns, as the assignee of the

entire right title and interest in and to the same, for the sole use and behalf of the ASSIGNEE and the ASSIGNEE's successors and assigns, to the full end of the term for which the Letters Patent may be granted, including the term of any and all divisions, continuations, substitutions, renewals, reexaminations, extensions and reissues thereof, as fully and entirely as the same would have been held by the ASSIGNORS had this assignment not been made;

ASSIGNORS hereby authorize said ASSIGNEE, its successors and assigns, to file in its own name applications for patent in foreign countries in connection with the inventions hereby transferred, under the International Convention claiming the priority of said United States application or otherwise, and to secure in its own name the Letters Patent issued thereon, including any and all divisions, continuations, substitutions, renewals, re-examinations, extensions and reissues thereof; and

ASSIGNORS hereby agree that, upon request, ASSIGNORS will sign all papers, and make all rightful oaths, and do all acts which said ASSIGNEE, its successors or assigns, may consider necessary in connection with said United States application, and in connection with any other United States application or foreign applications that may be filed in connection with said inventions, and with any improvements thereon, and in connection with any Letters Patent issued thereon, including any and all divisions, continuations, substitutions, renewals, re-examinations, extensions and reissues thereof.

ASSIGNORS:

By:

Fene Zhou

Date:

By. 8

Ercan Mehmet Dede

Date

212212018

12273403v1

REEL: 049710 FRAME: 0908